



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Garnik Taheri
SERIAL NO.: 10/754,807
FILING DATE: January 8, 2004 CONFIRMATION NO.: 1589
TITLE: SINGLE IC PACKAGING SOLUTION FOR MULTI CHIP
MODULES
EXAMINER: Roy Karl Potter
ART UNIT: 2822

CERTIFICATE OF MAILING

I hereby certify that this paper is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment Commissioner for Patents, P.O. Box 1450, Alexandria VA 22313-1450, on the date printed below:

Date: 11/16/05

Name: Michelle R. Crosby

Michelle R. Crosby

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE TO OFFICE ACTION

Dear Sir:

This paper is responsive to the Office Action mailed **August 10, 2005**. Please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims, which begins on page 4 of this paper.

Remarks begin on page 8 of this paper.